

**Facility Management Division**

Prime(H0)/FMD/Proc./RFQ/V. Prepaid/2021/

March 21, 2021

Subject: RFQ for Supply of Chip Based Non-Embossed Blank Plastic Cards for Visa Prepaid.

Dear Concerned,

You are requested to submit quotation in sealed envelope in your company letter head pad for **Supply of Chip Based Non-Embossed Blank Plastic Cards for Visa Prepaid** on the basis of following specifications and terms & conditions and Technical Specifications which is attached herewith as Annexure –A.

**Quantity and Specifications for Credit & Debit cards**

**Quantity of blank chip based non-embossed credit and debit cards:**

Prepaid Card	Product Name	Required Quantity (pcs)
Visa	Platinum	10,000
<b>Total Quantities</b>		<b>10,000</b>

It may be mentioned here that sealed quotation shall have to be submitted in the tender box kept at FMD, Facilities Tower (6<sup>th</sup> Floor), Kha-199/2, Maddhya Badda, Pragati Sarani, Dhaka-1212 by **March 29, 2021 by 03:00 p.m.** and clearly marked "**RFQ for Supply of Chip Based Non-Embossed Blank Plastic Cards for Visa Prepaid**" on the top of the envelope. The quotation will be opened on the same day and have to be validated for next 3-months from sample approval date.

VAT, Income Tax etc. shall be applicable as per Govt. rules.


The Bank reserves the right to accept or reject any or all the offers in full or part with or without assigning any reason whatsoever and Bank shall not be under any obligation to accept the lowest quotation.

Thanking You.

Regards,



Md. Mahfuzur Rahman  
AVP, General Service



Syed Ibne Shariar  
SAVP & Head of FMD

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Annexure: A

**Technical Specifications**
**(a) Generic Product & Minimum Chip Specifications:**

Technical Features	PBL Requirement	Bidders response
Plastic Material	PVC	
Plastic Quality	Please specify (North America/European standard etc.)	
Plastic Size	ISO Standard CR-80 (86 mm × 54 mm)	
Plastic Thickness	Minimum 0.76 mm	
Plastic Edge	Rounded Corner	
Plastic Lamination	Matte finishing	
Magnetic Type	ISO Standard Hi-CO 3 Tracks	
Track Data	3 Track Data	
Chip Product Technical Name, Version & Expiry	Vendor will specify	
Chip Hardware Manufacturer	Vendor will specify	
Chip Application OEM	Vendor will specify (Single/Multi)	
Country of Origin	Vendor will specify	
Design	As per Bank's Design	
Operating System	Java v2.2.1 for VISA	
Chip PIN	6 PIN	
Chip Type	VSDC for VISA	
Contact Protocol	T=0, T=1	
Authentication Type	DDA,CDA or Both	
Data Encryption Standard	AES/3 DES/RSA DDA CAPABLE	
Memory	a) RAM: Please specify b) EEPROM: Minimum 12KB or higher, please specify c) ROM: please specify	
Chip Re-Writeable option	Pease specify	
Application & Certification	VISA: VSDC 2.8.1F1 or higher	
EMV Spec	4.3	
Global Platform	2.1.1 or higher	
Interface	Contact	
Chip Manufacturer	Please specify	
Processor Manufacturer	Please specify	
Chip Module Color	Platinum VISA prepaid	
Chip Certification Validity	Vendor will specify	
Hologram & Ultraviolet Logos	VISA Standard	
Operating Temperature	The card have to pass heating under the lamination process	
Signature Panel	VISA standard	
LOA	Must approved from VISA	